

# Hyperspectral Compressive Imaging

Tech ID: 33793 / UC Case 2021-604-0

## ABSTRACT

Researchers at the University of California, Davis have developed two designs capable of capturing hyperspectral images that can be processed using compressive sensing techniques. These advanced component technologies for hyper-spectral imagers realizing 100x reduced size, weight, and power while supporting 1000x framerates in support of high performance.

## FULL DESCRIPTION

Hyperspectral imaging captures a wide range of wavelengths in the electromagnetic spectrum. Since materials emit or reflect unique combinations of electromagnetic radiation, hyperspectral imaging is useful for identifying specific materials in astronomy, chemistry, environmental imaging, and other research fields. Most hyperspectral imaging setups require large optical grating devices to take up significant amounts of space and suffer from poor resolving strength relative to the amount of power consumed. Furthermore, hyperspectral imaging is not often used with compressive signal processing techniques, which limits the maximum signal bandwidth that can be captured. The creation of a more compact hyperspectral imaging device that is compatible with compressive sensing is needed for a variety of applications.

Researchers at UC Davis have developed two novel designs to achieve hyperspectral compressive imaging in a compact form factor.

- ▶ The first method involves using metalenses to capture images at different wave polarizations, where each lens has a reconfigurable aperture. This design's versatility allows for optimization for various imaging applications that can be trained with machine learning algorithms.
- ▶ The second proposed method uses an array of waveguide routers to capture hyperspectral image data. Both techniques can capture data across several wavelength spectra simultaneously, offering an advantage over the common line-scan approach.

Each design is compatible with compressive sensing imaging processing and requires less sophisticated hardware to fit in a compact footprint. This high-resolution hyperspectral imaging system is useful in various tasks due to its compact design, image resolution, and power efficiency.

## APPLICATIONS

- ▶ Snapshot spectral imaging to capture multiple light wavelength spectra simultaneously
- ▶ Material detection in geology, astronomy, chemistry, other fields

## FEATURES/BENEFITS

- ▶ Up to 1000x more power and size efficient than existing hyperspectral imaging solutions

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## INVENTORS

- ▶ Yoo, S.J. Ben

## OTHER INFORMATION

### KEYWORDS

hyperspectral imaging,  
compressive sensing,  
metalens, waveguide  
router

### CATEGORIZED AS

- ▶ **Optics and Photonics**
  - ▶ All Optics and Photonics
- ▶ **Imaging**
  - ▶ 3D/Immersive
- ▶ **Medical**
  - ▶ Imaging
- ▶ **Sensors & Instrumentation**
  - ▶ Analytical
  - ▶ Environmental Sensors
  - ▶ Medical

► High resolution images can be processed with compressive sensing hardware



Scientific/Research

PATENT STATUS

Country	Type	Number	Dated	Case
Patent Cooperation Treaty	Reference for National Filings	2022/225975	10/27/2022	2021-604

RELATED CASES

2021-604-0

Patent Pending

ADDITIONAL TECHNOLOGIES BY THESE INVENTORS

- Higher-Speed and More Energy-Efficient Signal Processing Platform for Neural Networks
- Crystal Orientation Optimized Optical Frequency Shifter
- Multi-Wavelength, Nanophotonic, Neural Computing System
- Athermal Nanophotonic Lasers
- Ultra-High Resolution Multi-Platform Heterodyne Optical Imaging
- Multi-Wavelength, Laser Array
- Optical Interposers for Embedded Photonics Integration
- Ultrahigh-Bandwidth Low-Latency Reconfigurable Memory Interconnects by Wavelength Routing
- Development of a CMOS-Compatible, Nano-photonic, Laser
- Energy Efficient and Scalable Reconfigurable All-to-All Switching Architecture
- Compressive High-Speed Optical Transceiver
- All-Optical Regenerators
- Tensorized Optical Neural Network Architecture
- Silicon Based Chirped Grating Emitter for Uniform Power Emission
- Energy-Efficient All-Optical Nanophotonic Computing
- All-To-All Interconnection With Wavelength Routing Devices
- 3D Photonic and Electronic Neuromorphic Artificial Intelligence
- Adapting Existing Computer Networks to a Quantum-Based Internet Future

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